

11/25/03
U.S. PTO
123003

THE COMMISSIONER FOR PATENTS
P.O. Box 1450, Alexandria, VA 22313-1450

Docket No. IME03-005

22390 U.S. PTO
10/748736
123003

Transmitted herewith for filing is the Patent Application of:

Inventor: **EE HUA WONG, RANJAN S/O RAJOO, POI SIONG TEO**

For: **WAFER LEVEL SUPER STRETCH SOLDER**

Enclosed are:

- ☒ **6** sheets of drawing(s) - formal.
- ☐ An assignment of the invention to *Agency for Science, Technology and Research, National University of Singapore, Georgia Tech Research Corporation*
- ☐ An associate power of attorney ☐ Applicant claims small entity status
- ☐ Request & Certification under 35 USC 122(b)(2)(b)(i)

The filing fee has been calculated as shown below:

	(Col. 1)	(Col. 2)	OTHER THAN A SMALL ENTITY	
FOR:	NO. FILED	NO. EXTRA	RATE	FEE
BASIC FEE				\$ 770.
TOTAL CLAIMS	31 -20=	11	x 18 =	\$ 198.
INDEP CLAIMS	7 -3=	4	x 86 =	\$ 344.
			SUB TOTAL	\$ 1,312.
			ASSIGNMENT	\$
			TOTAL	\$ 1,312.

- ☒ Please charge my Deposit Account No. 19-0033 in the amount of \$ **1,312**. A duplicate copy of this sheet is enclosed.
- ☒ The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 19-0033. A duplicate copy of this sheet is enclosed.
 - ☒ Any additional filing fees required under 37 CFR §1.16.
 - ☒ Any patent application processing fees under 37 CFR §1.17.

Respectfully submitted
Stephen B. Ackerman
STEPHEN B. ACKERMAN, REG. NO. 37,761

EXPRESS MAIL CERTIFICATE

Express Mail No. **EV385357584US**
I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to Assistant Commissioner of Patents, Alexandria, VA, 22313-1450. Applicant and/or Attorney requests the date of deposit as the Filing Date.
12/30/03
Date of deposit
Stephen B. Ackerman 12/30/03
Signature / Date